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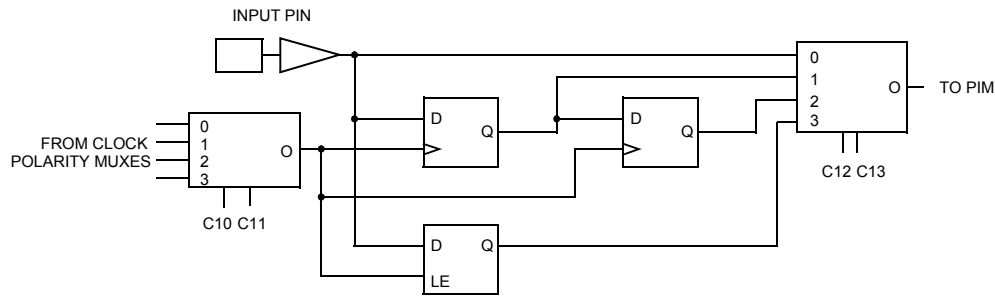
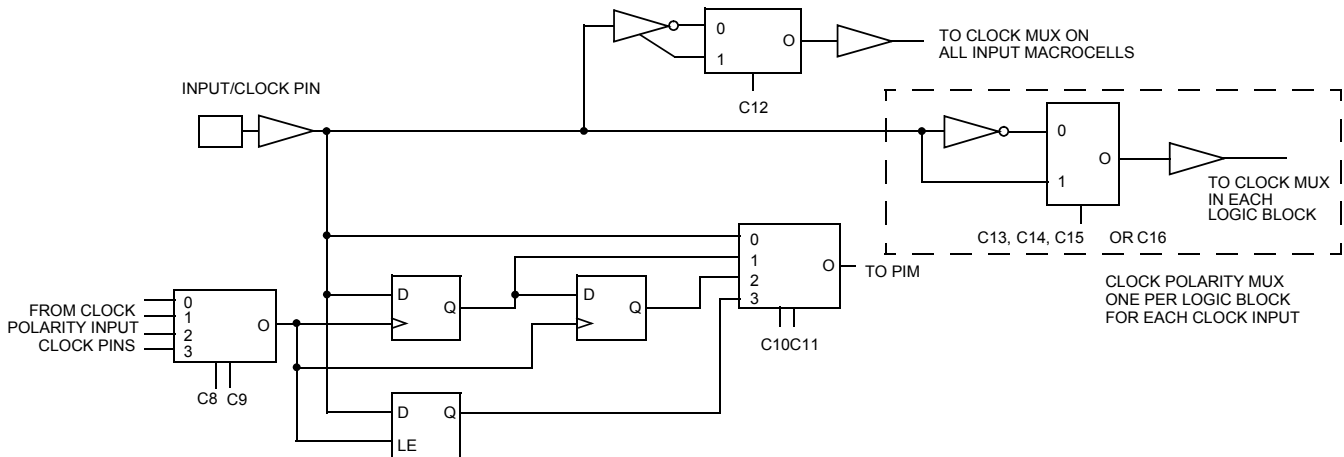
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	12 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	32
Number of Gates	-
Number of I/O	37
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.61x16.61)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy37032vp44-100jxi


Figure 3. Input Macrocell

Figure 4. Input/Clock Macrocell

Clocking

Each I/O and buried macrocell has access to four synchronous clocks (CLK0, CLK1, CLK2 and CLK3) as well as an asynchronous product term clock PTCLK. Each input macrocell has access to all four synchronous clocks.

Dedicated Inputs/Clocks

Five pins on each member of the Ultra37000 family are designated as input-only. There are two types of dedicated inputs on Ultra37000 devices: input pins and input/clock pins. *Figure 3* illustrates the architecture for input pins. Four input options are available for the user: combinatorial, registered, double-registered, or latched. If a registered or latched option is selected, any one of the input clocks can be selected for control.

Figure 4 illustrates the architecture for the input/clock pins. Like the input pins, input/clock pins can be combinatorial, registered, double-registered, or latched. In addition, these pins feed the clocking structures throughout the device. The clock path at the input has user-configurable polarity.

Product Term Clocking

In addition to the four synchronous clocks, the Ultra37000 family also has a product term clock for asynchronous clocking. Each logic block has an independent product term clock which is available to all 16 macrocells. Each product term clock also supports user configurable polarity selection.

Timing Model

One of the most important features of the Ultra37000 family is the simplicity of its timing. All delays are worst case and system performance is unaffected by the features used. *Figure 5* illustrates the true timing model for the 167-MHz devices in high speed mode. For combinatorial paths, any input to any output incurs a 6.5-ns worst-case delay regardless of the amount of logic used. For synchronous systems, the input set-up time to the output macrocells for any input is 3.5 ns and the clock to output time is also 4.0 ns. These measurements are for any output and synchronous clock, regardless of the logic used.

The Ultra37000 features:

- No fanout delays
- No expander delays
- No dedicated vs. I/O pin delays
- No additional delay through PIM
- No penalty for using 0–16 product terms
- No added delay for steering product terms
- No added delay for sharing product terms
- No routing delays
- No output bypass delays

The simple timing model of the Ultra37000 family eliminates unexpected performance penalties.

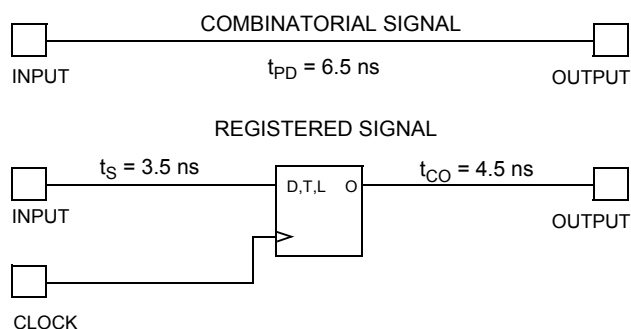


Figure 5. Timing Model for CY37128

JTAG and PCI Standards

PCI Compliance

5V operation of the Ultra37000 is fully compliant with the PCI Local Bus Specification published by the PCI Special Interest Group. The 3.3V products meet all PCI requirements except for the output 3.3V clamp, which is in direct conflict with 5V tolerance. The Ultra37000 family's simple and predictable timing model ensures compliance with the PCI AC specifications independent of the design.

IEEE 1149.1-compliant JTAG

The Ultra37000 family has an IEEE 1149.1 JTAG interface for both Boundary Scan and ISR.

Boundary Scan

The Ultra37000 family supports Bypass, Sample/Preload, Extest, Idcode, and Usercode boundary scan instructions. The JTAG interface is shown in Figure 6.

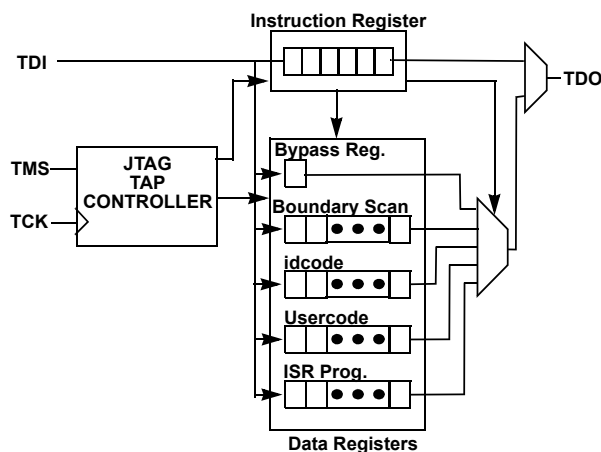


Figure 6. JTAG Interface

In-System Reprogramming (ISR)

In-System Reprogramming is the combination of the capability to program or reprogram a device on-board, and the ability to support design changes without changing the system timing or device pinout. This combination means design changes during debug or field upgrades do not cause board respins. The Ultra37000 family implements ISR by providing a JTAG compliant interface for on-board programming, robust routing

resources for pinout flexibility, and a simple timing model for consistent system performance.

Development Software Support

Warp

Warp is a state-of-the-art compiler and complete CPLD design tool. For design entry, Warp provides an IEEE-STD-1076/1164 VHDL text editor, an IEEE-STD-1364 Verilog text editor, and a graphical finite state machine editor. It provides optimized synthesis and fitting by replacing basic circuits with ones pre-optimized for the target device, by implementing logic in unused memory and by perfect communication between fitting and synthesis. To facilitate design and debugging, Warp provides graphical timing simulation and analysis.

Warp Professional™

Warp Professional contains several additional features. It provides an extra method of design entry with its graphical block diagram editor. It allows up to 5 ms timing simulation instead of only 2 ms. It allows comparison of waveforms before and after design changes.

Warp Enterprise™

Warp Enterprise provides even more features. It provides unlimited timing simulation and source-level behavioral simulation as well as a debugger. It has the ability to generate graphical HDL blocks from HDL text. It can even generate testbenches.

Warp is available for PC and UNIX platforms. Some features are not available in the UNIX version. For further information see the Warp for PC, Warp for UNIX, Warp Professional and Warp Enterprise data sheets on Cypress's web site (www.cypress.com).

Third-Party Software

Although Warp is a complete CPLD development tool on its own, it interfaces with nearly every third party EDA tool. All major third-party software vendors provide support for the Ultra37000 family of devices. Refer to the third-party software data sheet or contact your local sales office for a list of currently supported third-party vendors.

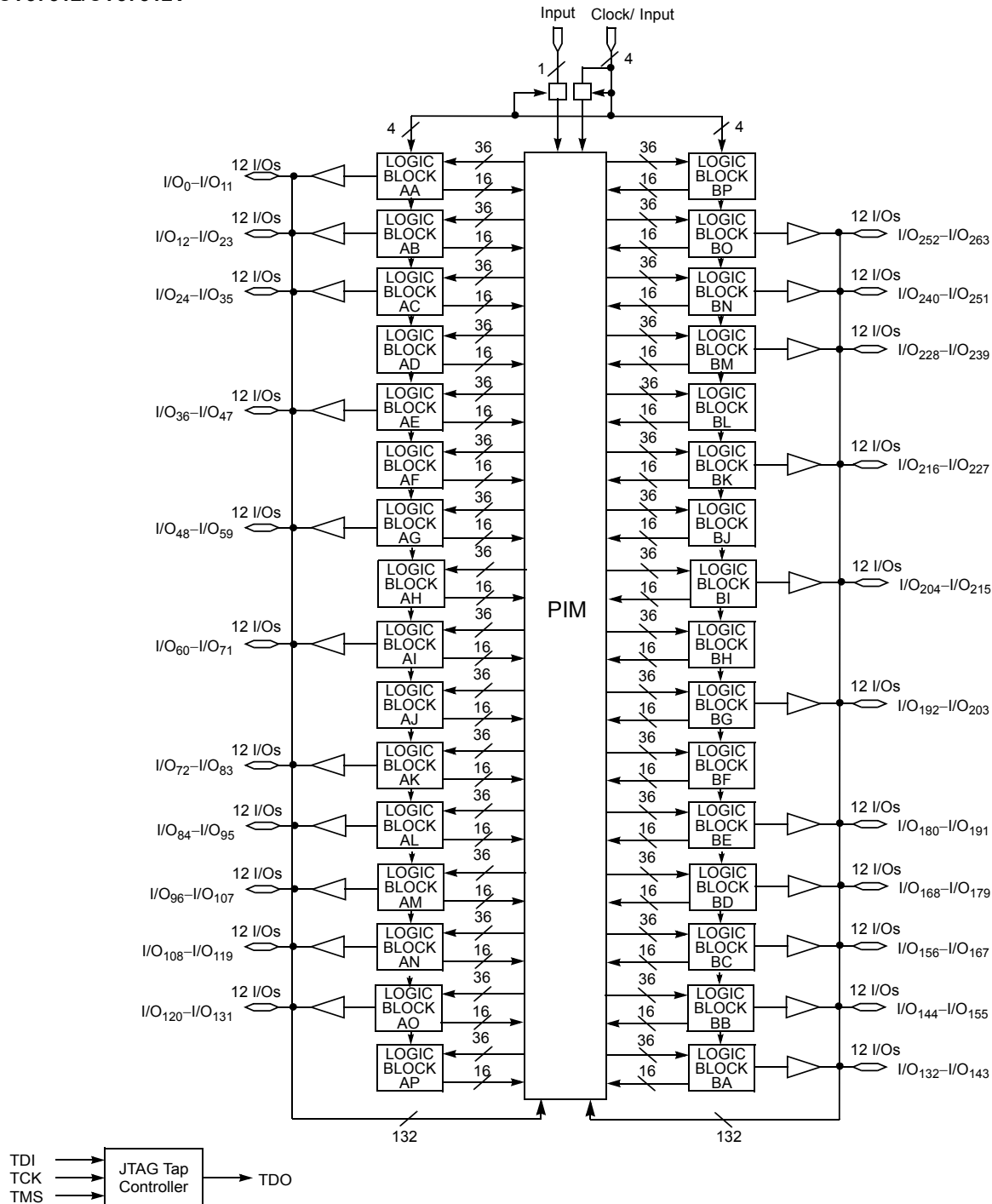
Programming

There are four programming options available for Ultra37000 devices. The first method is to use a PC with the 37000 UltraISR programming cable and software. With this method, the ISR pins of the Ultra37000 devices are routed to a connector at the edge of the printed circuit board. The 37000 UltraISR programming cable is then connected between the parallel port of the PC and this connector. A simple configuration file instructs the ISR software of the programming operations to be performed on each of the Ultra37000 devices in the system. The ISR software then automatically completes all of the necessary data manipulations required to accomplish the programming, reading, verifying, and other ISR functions. For more information on the Cypress ISR Interface, see the ISR Programming Kit data sheet (CY3700i).

The second method for programming Ultra37000 devices is on automatic test equipment (ATE). This is accomplished through a file created by the ISR software. Check the Cypress website for the latest ISR software download information.

Logic Block Diagrams (continued)

CY37512/CY37512V



Inductance^[5]

Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

Capacitance^[5]

Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	10	pF
C_{CLK}	Clock Signal Capacitance	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
C_{DP}	Dual-Function Pins ^[9]	$V_{IN} = 5.0V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

Endurance Characteristics^[5]

Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions ^[2]	1,000	10,000	Cycles

3.3V Device Characteristics
Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature $-65^\circ C$ to $+150^\circ C$

Ambient Temperature with
Power Applied $-55^\circ C$ to $+125^\circ C$

Supply Voltage to Ground Potential $-0.5V$ to $+4.6V$

DC Voltage Applied to Outputs

in High-Z State $-0.5V$ to $+7.0V$

DC Input Voltage $-0.5V$ to $+7.0V$

DC Program Voltage 3.0 to $3.6V$

Current into Outputs 8 mA

Static Discharge Voltage $> 2001V$
(per MIL-STD-883, Method 3015)

Latch-up Current $> 200\text{ mA}$

Operating Range^[2]

Range	Ambient Temperature ^[2]	Junction Temperature	V_{CC} ^[10]
Commercial	$0^\circ C$ to $+70^\circ C$	$0^\circ C$ to $+90^\circ C$	$3.3V \pm 0.3V$
Industrial	$-40^\circ C$ to $+85^\circ C$	$-40^\circ C$ to $+105^\circ C$	$3.3V \pm 0.3V$
Military ^[3]	$-55^\circ C$ to $+125^\circ C$	$-55^\circ C$ to $+130^\circ C$	$3.3V \pm 0.3V$

3.3V Device Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	$V_{CC} = \text{Min.}$ $I_{OH} = -4\text{ mA (Com'I)}^{[4]}$ $I_{OH} = -3\text{ mA (Mil)}^{[4]}$	2.4		V
V_{OL}	Output LOW Voltage	$V_{CC} = \text{Min.}$ $I_{OL} = 8\text{ mA (Com'I)}^{[4]}$ $I_{OL} = 6\text{ mA (Mil)}^{[4]}$		0.5	V
V_{IH}	Input HIGH Voltage	Guaranteed Input Logical HIGH Voltage for all Inputs ^[7]	2.0	5.5	V
V_{IL}	Input LOW Voltage	Guaranteed Input Logical LOW Voltage for all Inputs ^[7]	-0.5	0.8	V
I_{IX}	Input Load Current	$V_I = \text{GND OR } V_{CC}$, Bus-Hold Disabled	-10	10	μA
I_{OZ}	Output Leakage Current	$V_O = \text{GND or } V_{CC}$, Output Disabled, Bus-Hold Disabled	-50	50	μA
I_{OS}	Output Short Circuit Current ^[5, 8]	$V_{CC} = \text{Max.}$, $V_{OUT} = 0.5V$	-30	-160	mA
I_{BHL}	Input Bus-Hold LOW Sustaining Current	$V_{CC} = \text{Min.}$, $V_{IL} = 0.8V$	+75		μA
I_{BHH}	Input Bus-Hold HIGH Sustaining Current	$V_{CC} = \text{Min.}$, $V_{IH} = 2.0V$	-75		μA
I_{BHLO}	Input Bus-Hold LOW Overdrive Current	$V_{CC} = \text{Max.}$		+500	μA
I_{BHHO}	Input Bus-Hold HIGH Overdrive Current	$V_{CC} = \text{Max.}$		-500	μA

Notes:

9. Dual pins are I/O with JTAG pins.

10. For CY37064VP100-143AC, CY37064VP100-143BBC, CY37064VP44-143AC, CY37064VP48-143BAC; Operating Range: V_{CC} is $3.3V \pm 0.16V$.

Inductance^[5]

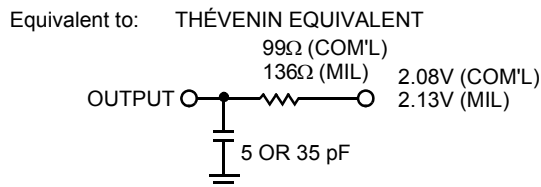
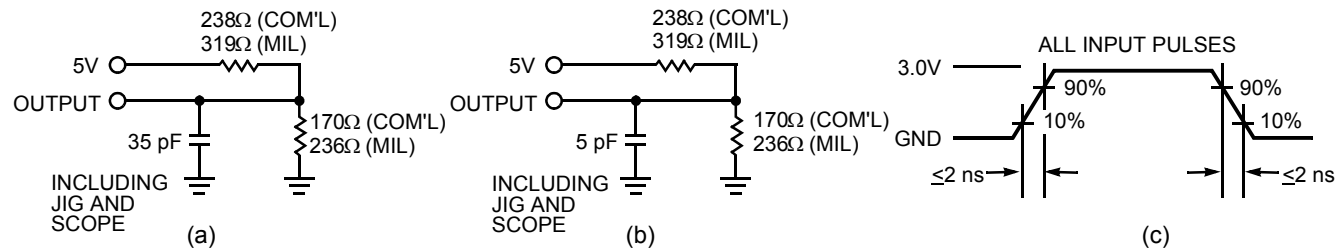
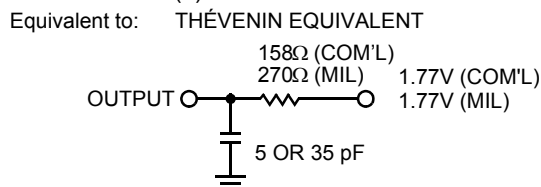
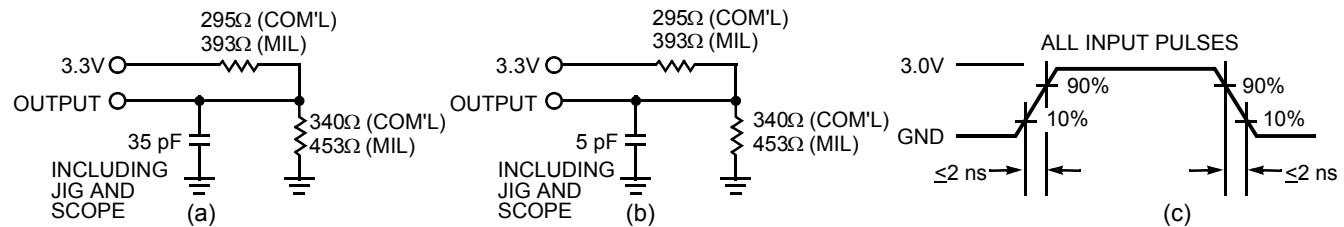
Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

Capacitance^[5]

Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	8	pF
C_{CLK}	Clock Signal Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
C_{DP}	Dual Functional Pins ^[9]	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

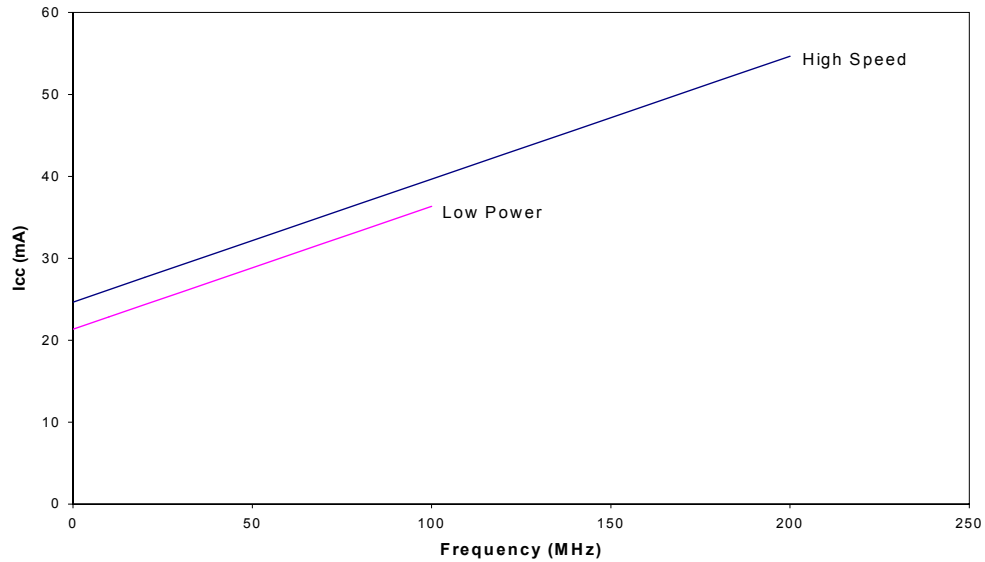
Endurance Characteristics^[5]

Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions ^[2]	1,000	10,000	Cycles

AC Characteristics
5.0V AC Test Loads and Waveforms

3.3V AC Test Loads and Waveforms


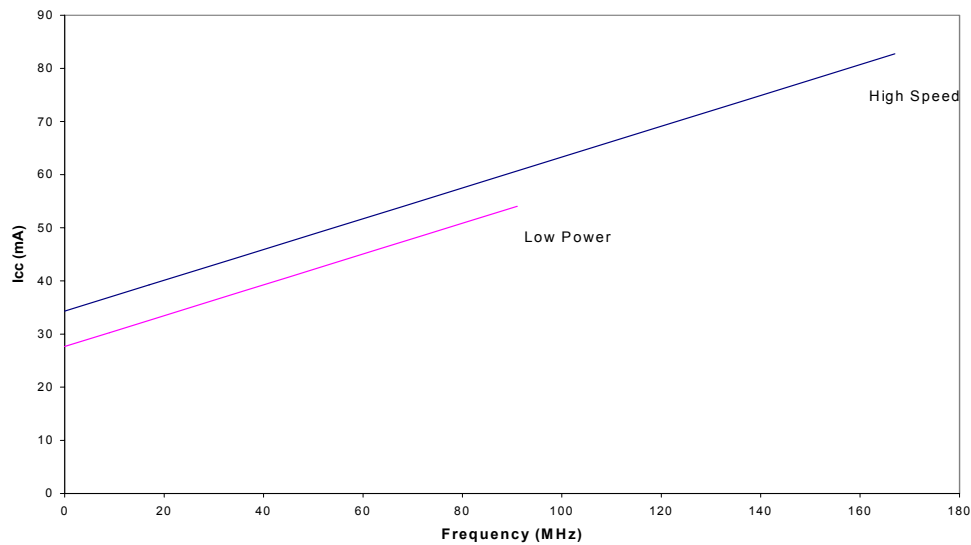
Power Consumption

Typical 5.0V Power Consumption CY37032

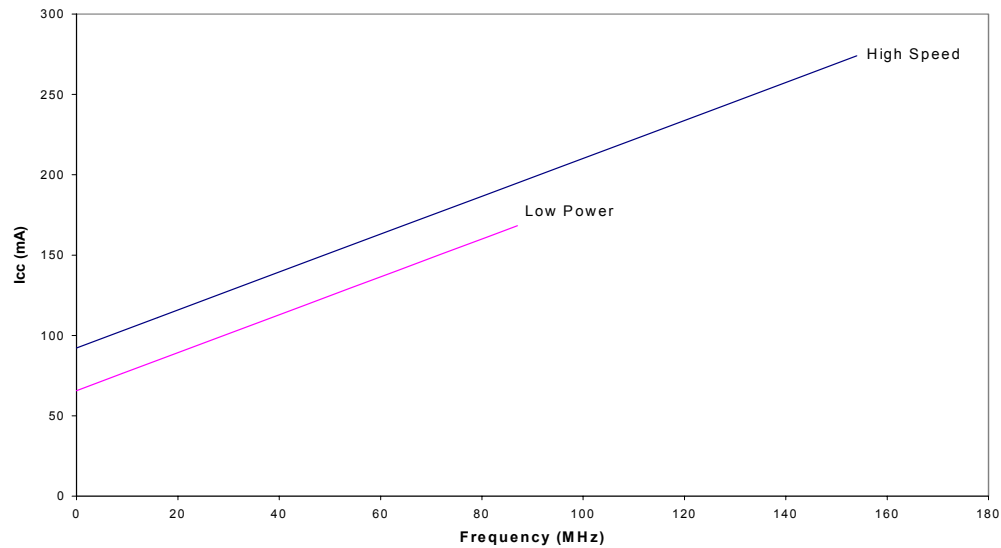


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

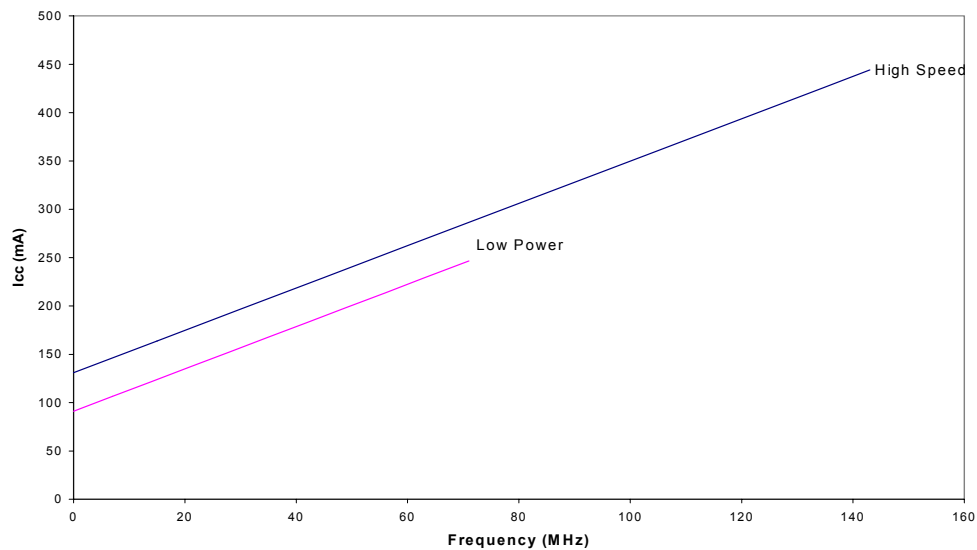
CY37064



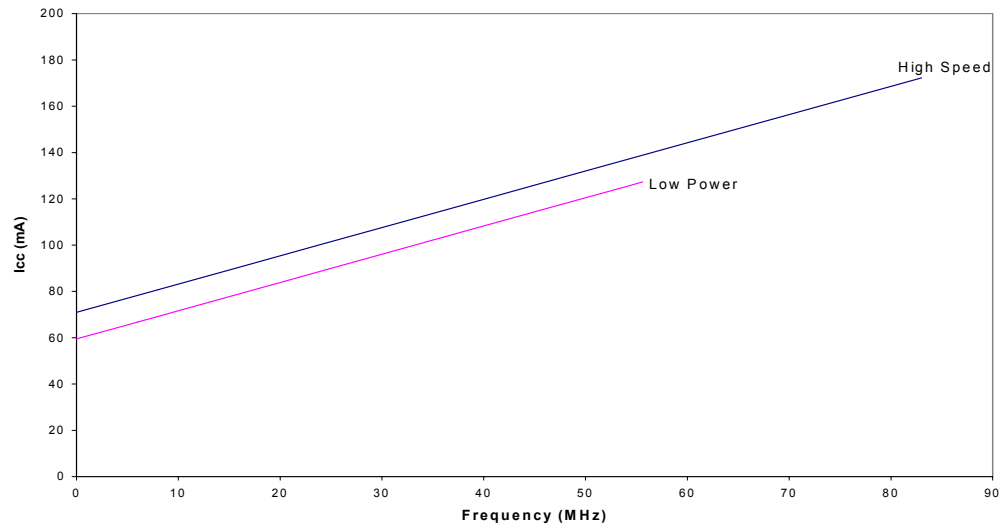
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
V_{CC} = 5.0V, T_A = Room Temperature

Typical 5.0V Power Consumption (continued)
CY37256


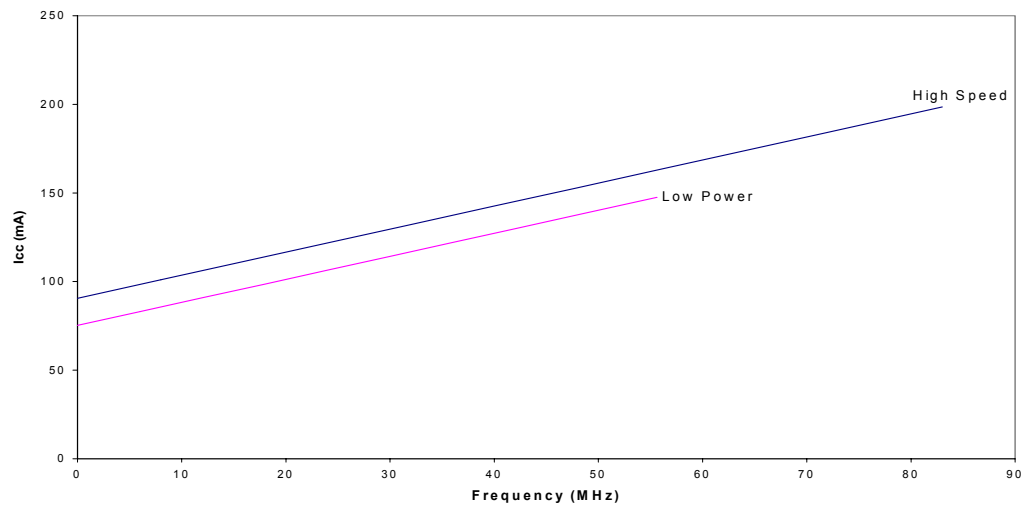
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

CY37384


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 5.0V$, $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)
CY37384V


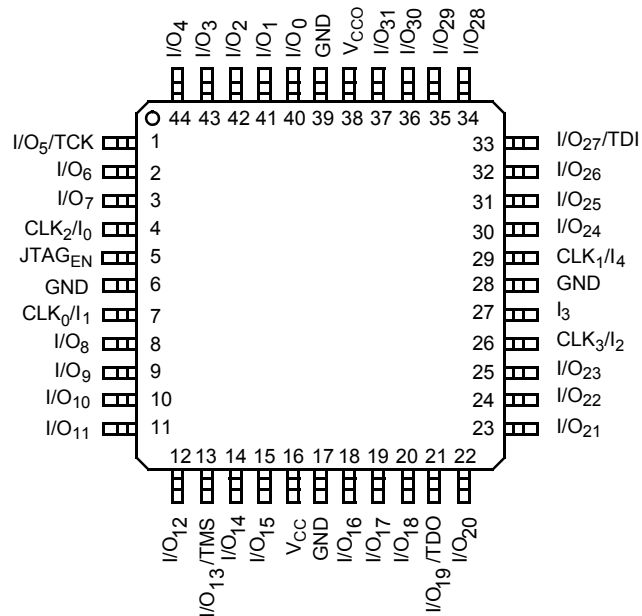
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 3.3V$, $T_A = \text{Room Temperature}$

CY37512V


The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.
 $V_{CC} = 3.3V$, $T_A = \text{Room Temperature}$

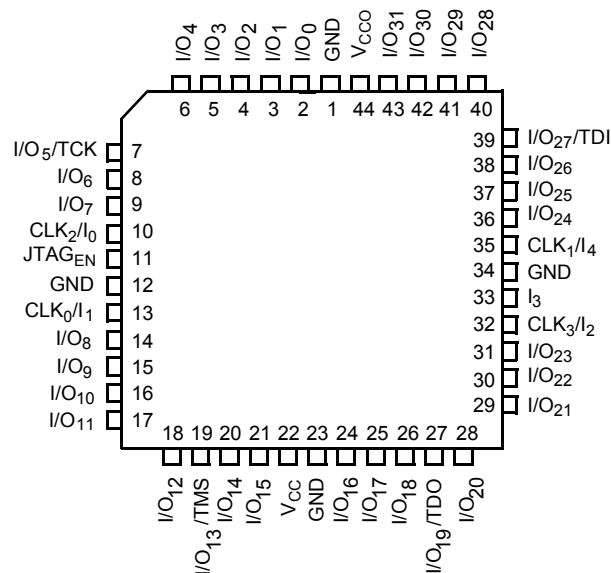
44-pin TQFP (A44)

Top View



44-pin PLCC (J67) / CLCC (Y67)

Top View

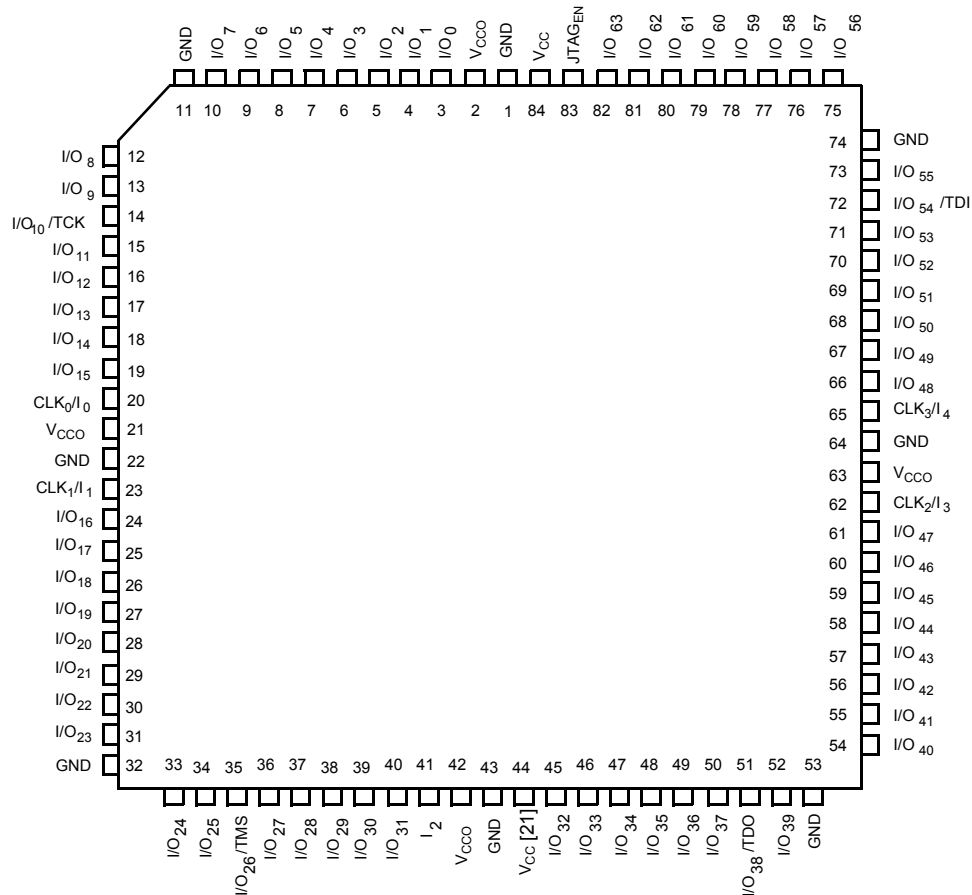


Pin Configurations^[20] (continued)
48-ball Fine-Pitch BGA (BA50)
Top View

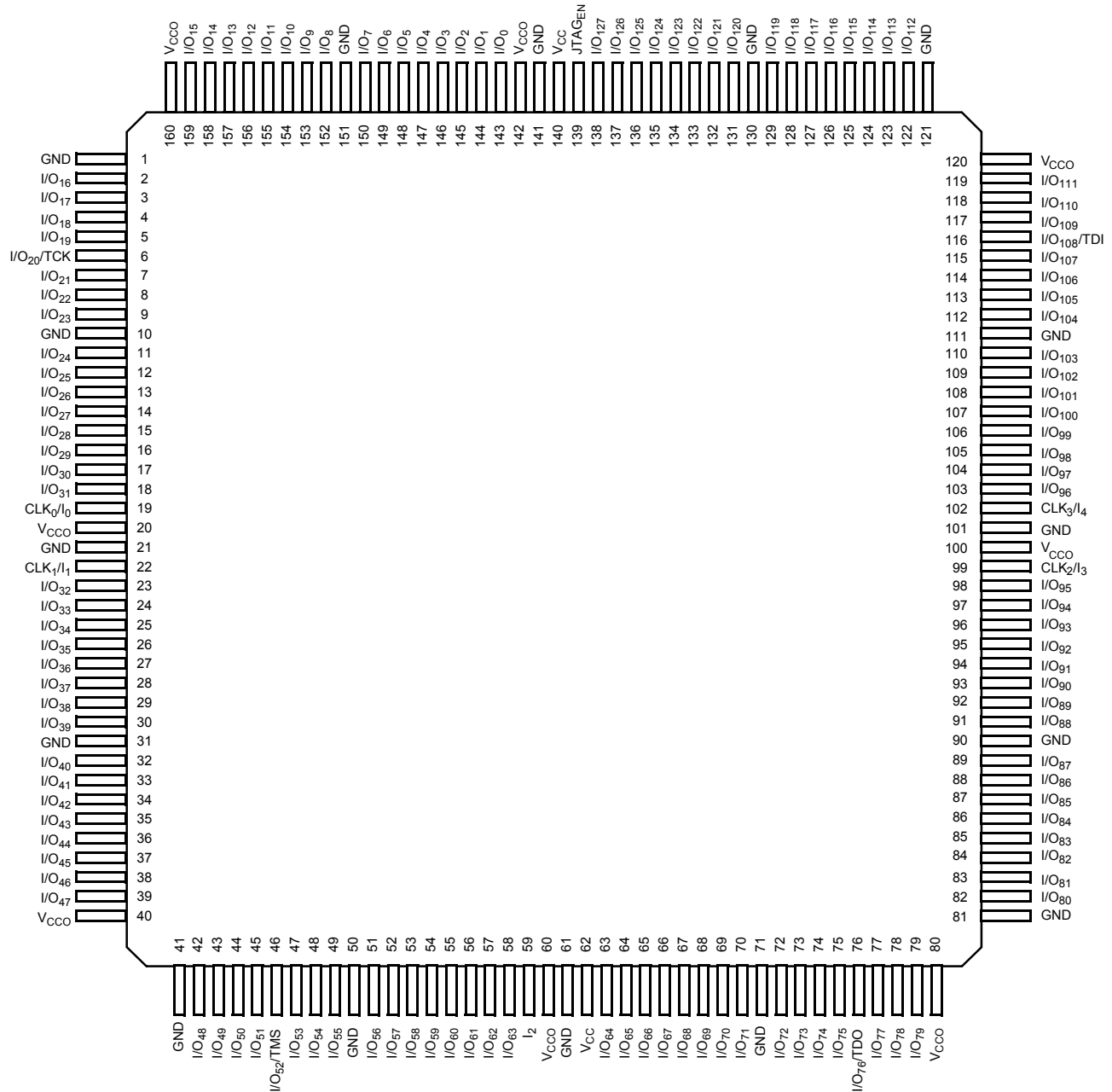
	1	2	3	4	5	6	7	8
A	I/O ₅ TCK	V _{CC}	I/O ₃	I/O ₁	I/O ₃₁	I/O ₃₀	V _{CC}	I/O ₂₇ TDI
B	V _{CC}	I/O ₄	I/O ₂	I/O ₀	I/O ₂₉	I/O ₂₈	I/O ₂₆	CLK ₁ /I ₄
C	CLK ₂ /I ₀	I/O ₇	I/O ₆	GND	GND	I/O ₂₅	I/O ₂₄	I ₃
D	JTAG _{EN}	I/O ₈	I/O ₉	GND	GND	I/O ₂₂	I/O ₂₃	CLK ₃ /I ₂
E	CLK ₀ /I ₁	I/O ₁₂	I/O ₁₁	I/O ₁₀	I/O ₁₆	I/O ₂₀	I/O ₂₁	V _{CC}
F	I/O ₁₃ TMS	V _{CC}	I/O ₁₄	I/O ₁₅	I/O ₁₇	I/O ₁₈	V _{CC}	I/O ₁₉ TDO

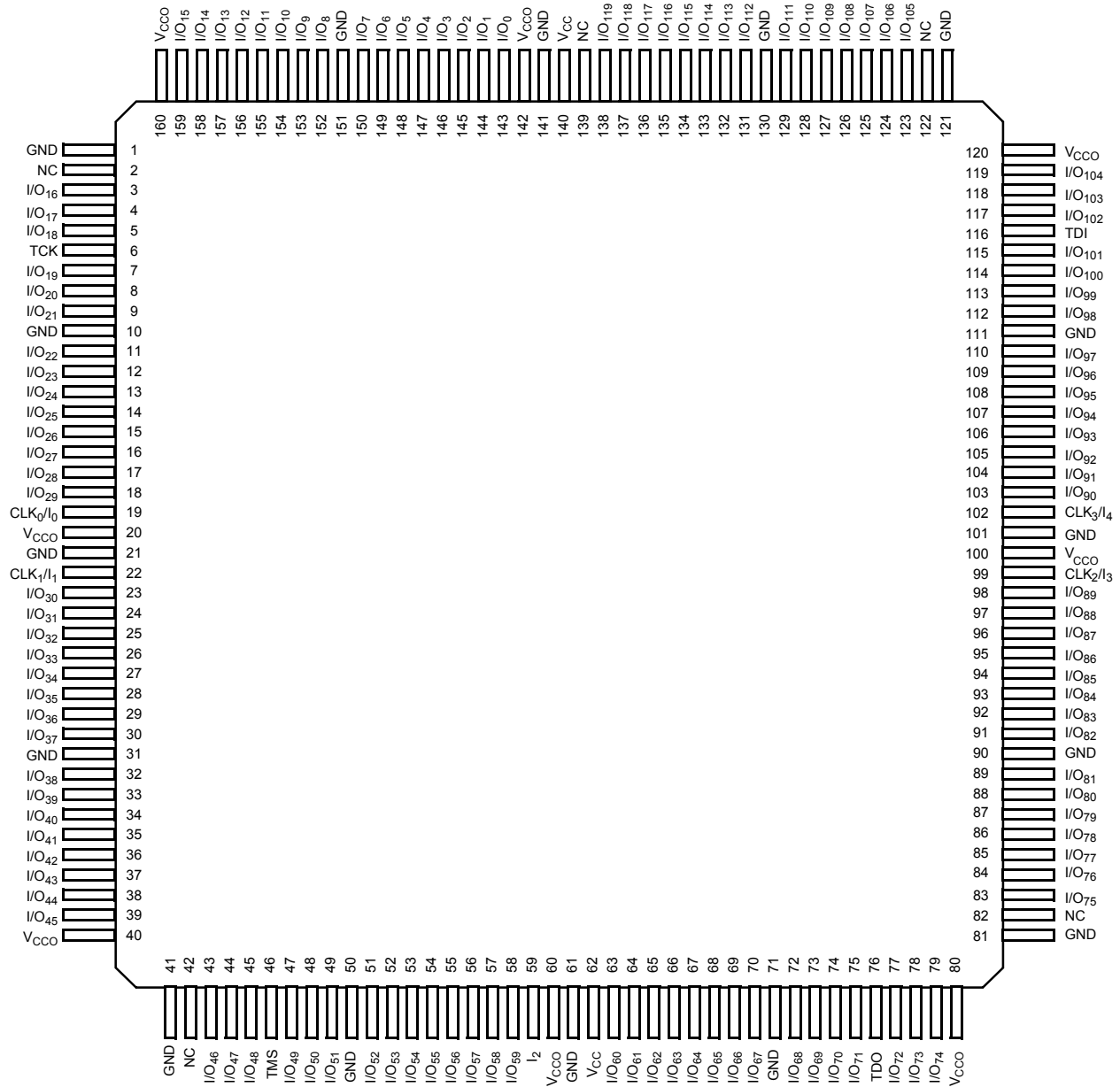
Note:

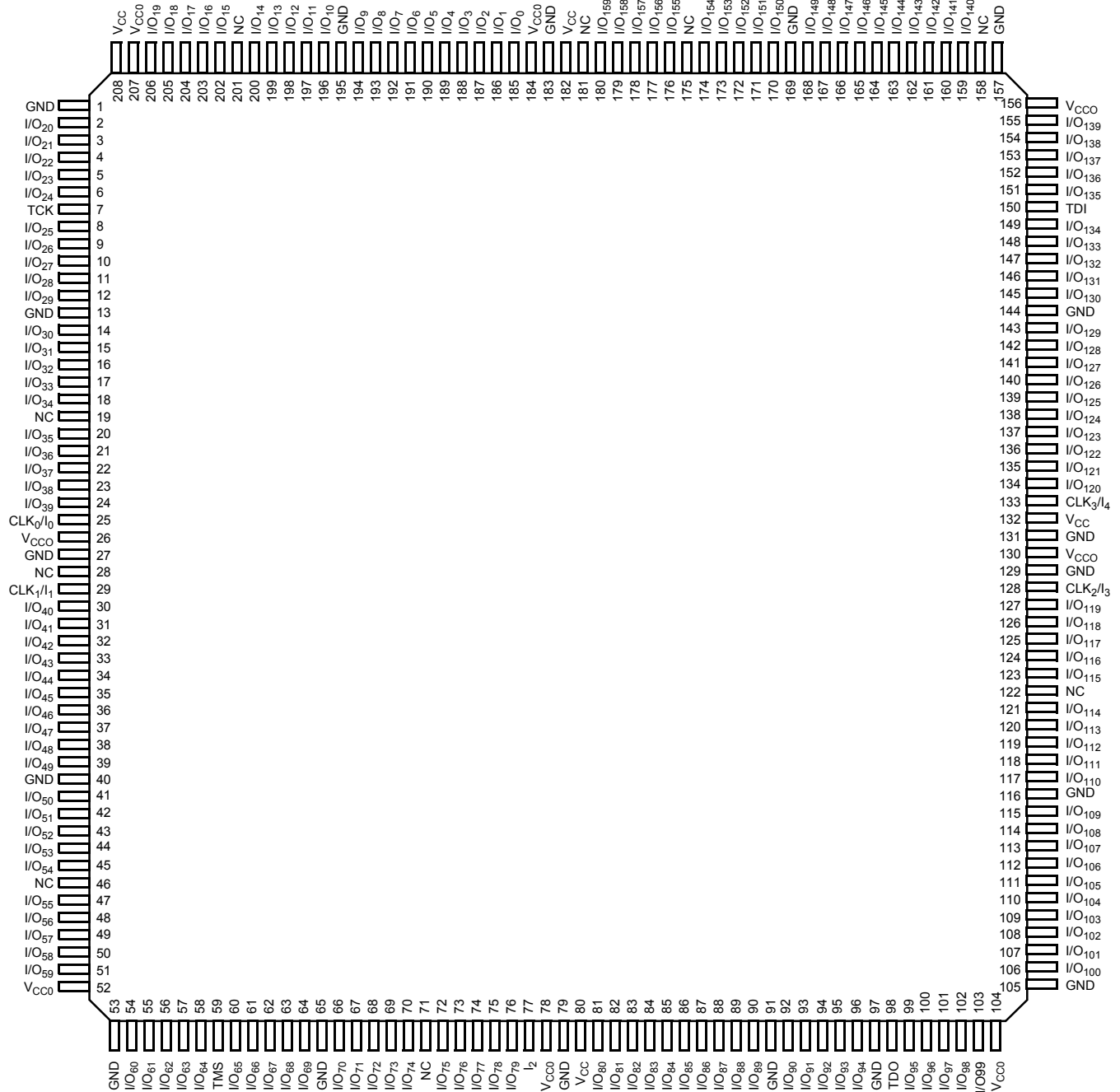
20. For 3.3V versions (Ultra37000V), V_{CCO} = V_{CC}.

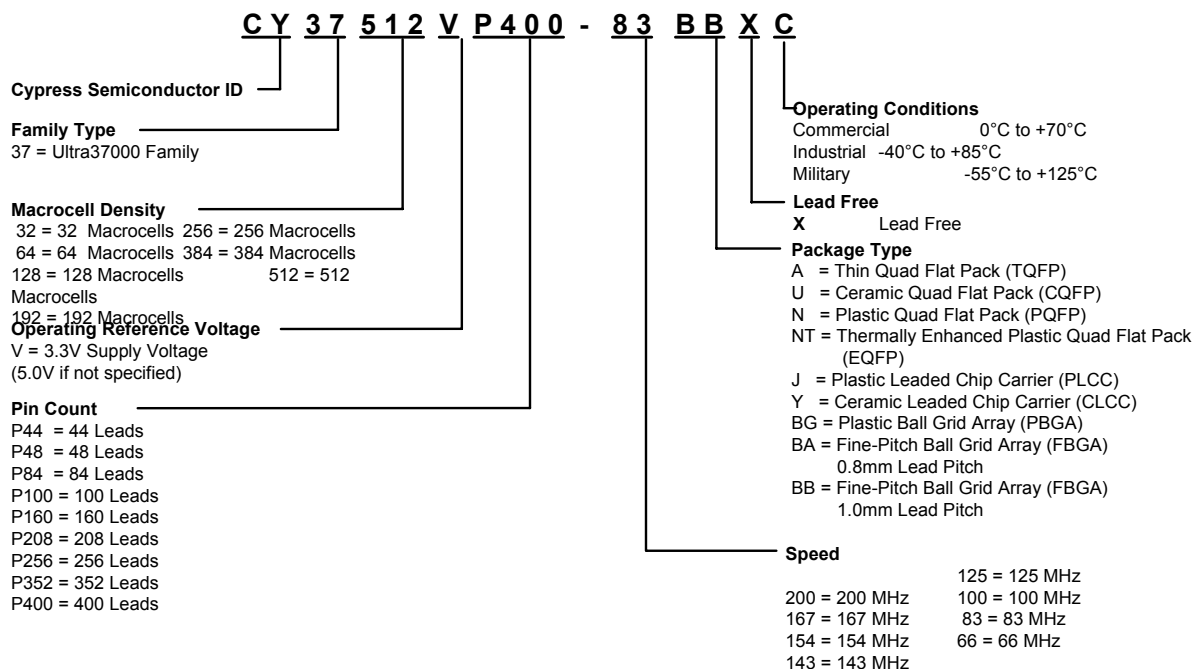
84-lead PLCC (J83) / CLCC (Y84)
Top View

Note:

21. This pin is a N/C, but Cypress recommends that you connect it to V_{CC} to ensure future compatibility.

Pin Configurations^[20] (continued)
**160-Lead TQFP (A160) / CQFP (U162)
for CY37128(V) and CY37256(V)
Top View**


Pin Configurations^[20] (continued)
**160-Lead TQFP (A160) for CY37192(V)
Top View**


Pin Configurations^[20] (continued)
**208-Lead PQFP (N208) / CQFP (U208)
Top View**


Ordering Information

5.0V Ordering Information

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
32	200	CY37032P44-200AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032P44-200AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032P44-200JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032P44-200JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
	154	CY37032P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37032P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
	125	CY37032P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37032P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37032P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37032P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37032P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37032P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
64	200	CY37064P44-200AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-200AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-200JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-200JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-200JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-200AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-200AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	

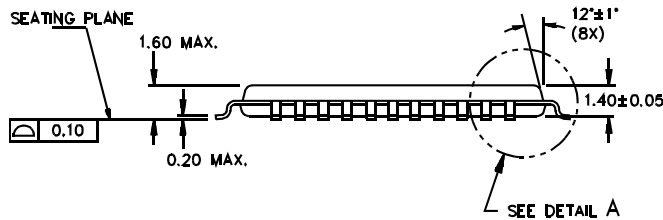
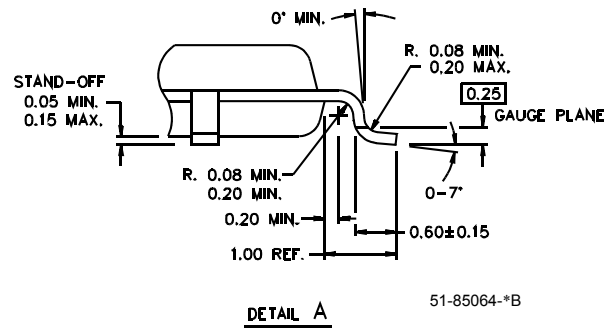
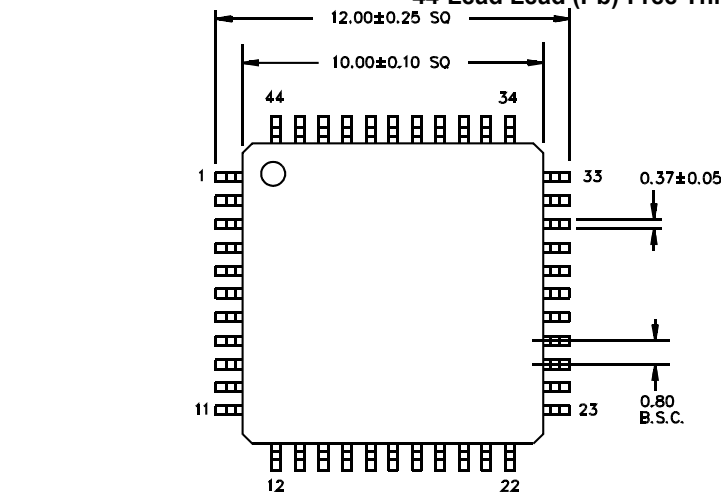
5.0V Ordering Information (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range
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		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack	
		5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military
	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
		CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
		CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
		CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
		CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier	
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack	
		CY37064P100-125AXI	A100	100-Lead Lead Free Thin Quad Flat Pack	Military
		5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	

Package Diagrams

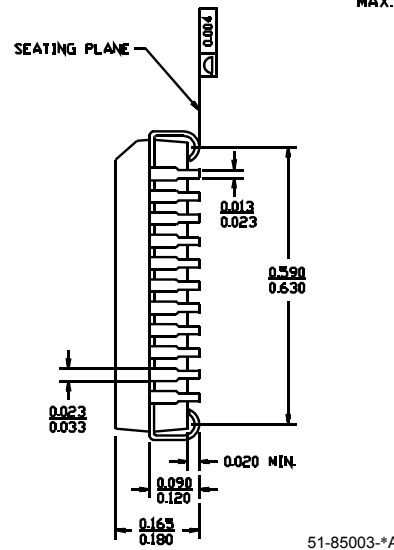
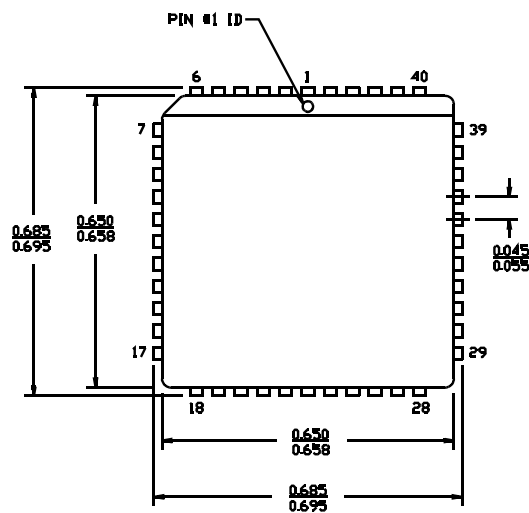
44-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack A44

DIMENSIONS ARE IN MILLIMETERS



44-Lead Lead (Pb)-Free Plastic Leaded Chip Carrier J67

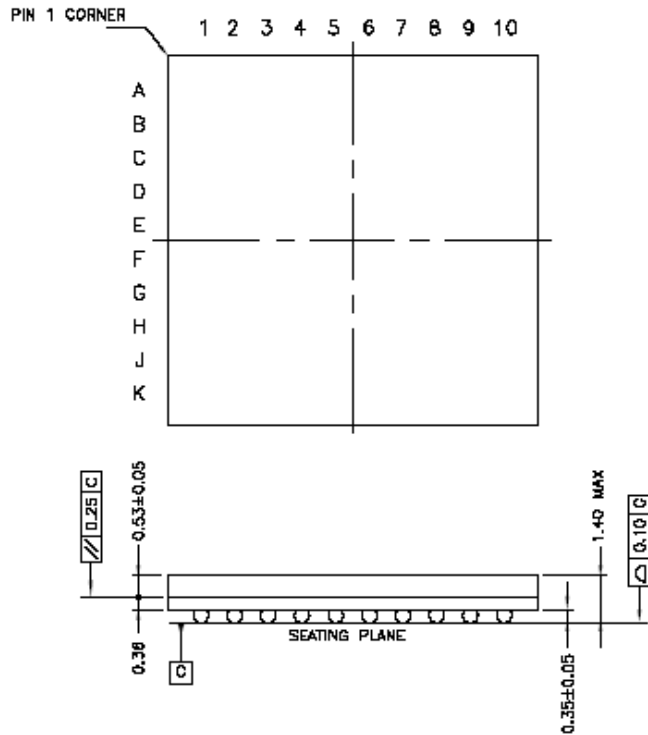
DIMENSIONS IN INCHES MIN. MAX.



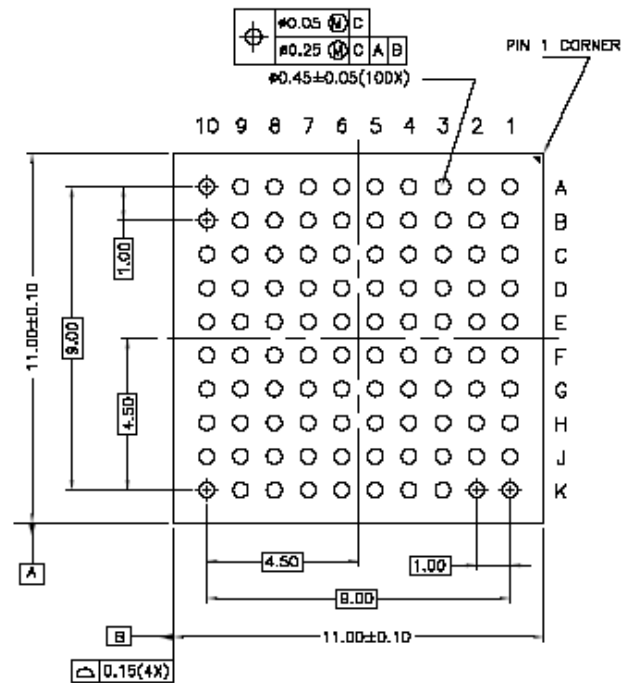
Package Diagrams (continued)

100-Ball Thin Ball Grid Array (11 x 11 x 1.4 mm) BB100

TOP VIEW



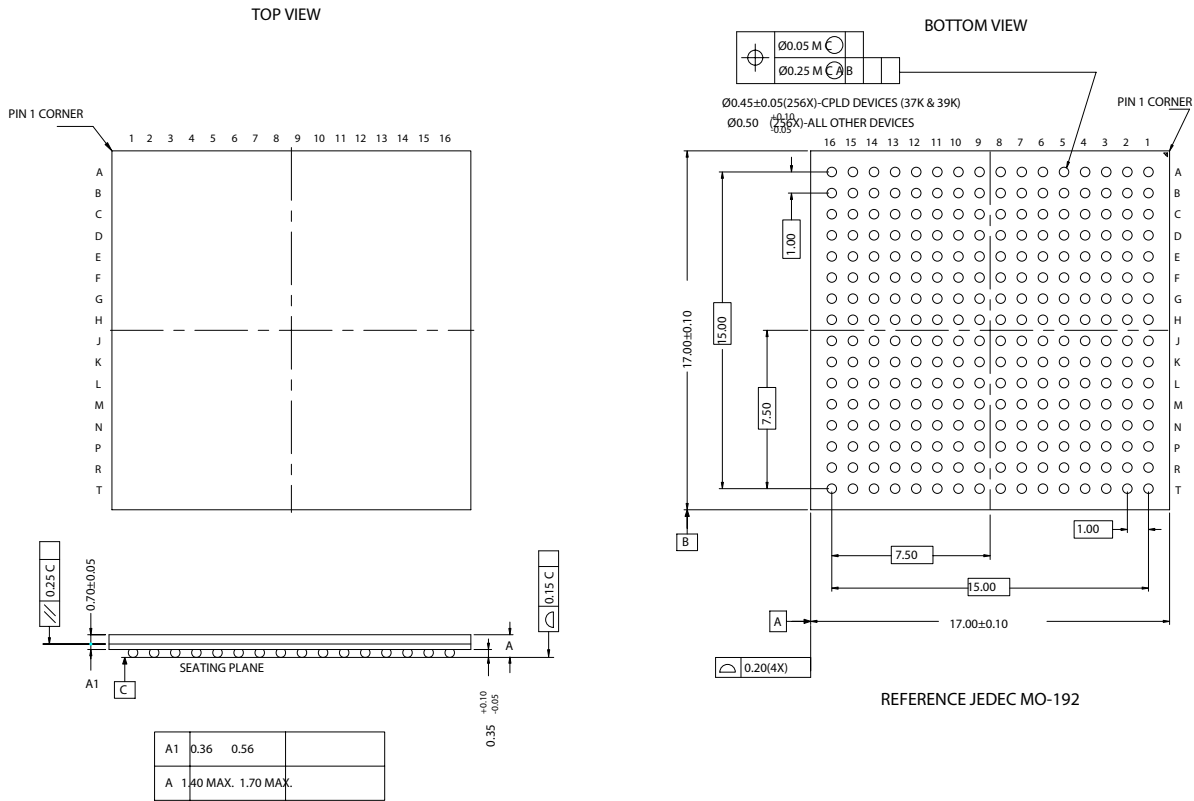
BOTTOM VIEW



51-85107-B

Package Diagrams (continued)

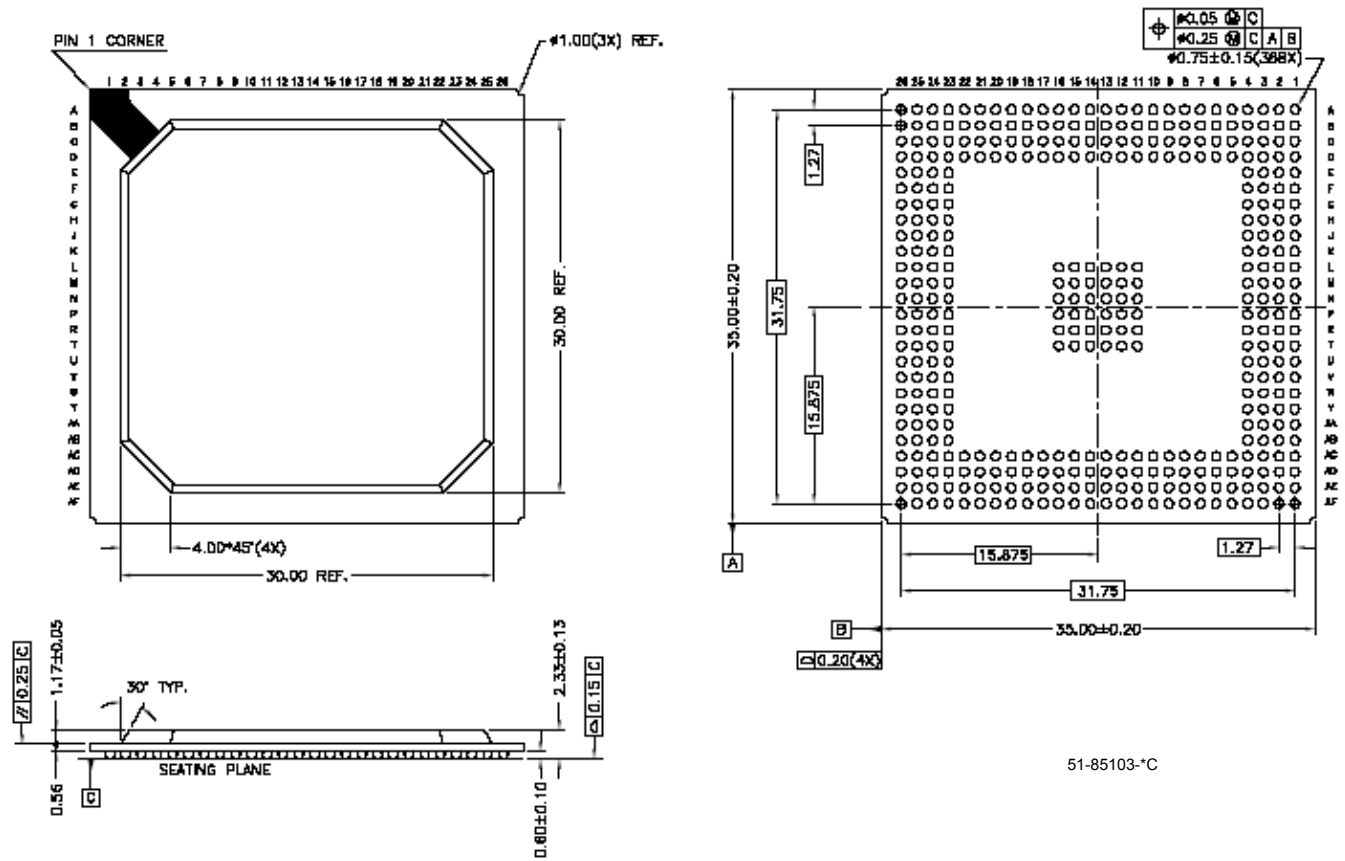
256-Ball FBGA (17 x 17 mm) BB256



51-85108-7F

Package Diagrams (continued)

388-Ball Plastic Ball Grid Array PBGA (35 x 35 x 2.33 mm) BG388



51-85103-°C

Document History Page

Document Title: Ultra37000 CPLD Family 5V, 3.3V, ISR™ High-Performance CPLDs Document Number: 38-03007				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	106272	04/18/01	SZV	Change from Spec number: 38-00475 to 38-03007
*A	124942	03/21/03	OOR	Updated 3.3V V _{CC} requirements for –144 speeds Added an Addendum
*B	126262	05/09/03	TEH	Changed pinout for CY37128V BB100 package
*C	128125	07/16/03	HOM	Obsoleted following 3.3V PLCC packaged devices: CY37032VP44-143JC CY37032VP44-100JC CY37032VP44-100JI CY37064VP44-143JC CY37064VP84-143JC CY37064VP44-100JC CY37064VP84-100JC CY37064VP44-100JI CY37064VP84-100JI CY37128VP84-125JC CY37128VP84-83JC CY37128VP84-83JI
*D	282709	See ECN	YDT	Changed package diagrams and labels for consistency Added Lead (Pb)-free logo on first page, as well as a note in Features Added Lead (Pb)-free package diagram labels Added Lead-free Parts to Ordering Information CY37032P44-200AXC, CY37032P44-200JXC, CY37032P44-154AXI, CY37032P44-154JXI, CY37032P44-125AXC, CY37032P44-125JXC, CY37064P44-200AXC, CY37064P44-200JXC, CY37064P100-200AXC, CY37064P44-154AXI, CY37064P44-154JXI, CY37064P44-125AXC, CY37064P44-125JXC, CY37064P100-125AXC, CY37064P44-125AXI, CY37064P100-125AXI, CY37128P84-167JXC, CY37128P100-167AXC, CY37128P160-167AXC, CY37128P84-125JXC, CY37128P100-125AXC, CY37128P160-125AXC, CY37128P84-125JXI, CY37128P100-125AXI, CY37128P160-125AXI, CY37128P84-100JXC, CY37128P100-100AXC, CY37128P160-100AXC, CY37128P100-100AXI, CY37192P160-154AXC, CY37192P160-125AXC, CY37192P160-125AXI, CY37192P160-83AXC, CY37192P160-83AXI, CY37256P160-154AXC, CY37256P160-125AXC, CY37256P160-125AXI, CY37256P160-83AXC, CY37256P160-83AXI, CY37032VP44-143AXC, CY37032VP44-100AXC, CY37032VP44-100AXI, CY37032VP44-100JXI, CY37064VP44-143AXC, CY37064VP100-143AXC, CY37064VP44-100AXC, CY37064VP100-100AXC, CY37064VP44-100AXI, CY37064VP100-100AXI, CY37128VP100-125AXC, CY37128VP160-125AXC, CY37128VP160-125AXI, CY37128VP100-83AXC, CY37128VP160-83AXC, CY37128VP100-83AXI, CY37128VP160-83AXI, CY37192VP160-100AXC, CY37192VP160-66AXC, CY37256VP160-100AXC, CY37256VP160-100AXI, CY37256VP160-66AXC
*E	321635	See ECN	PCX	Added Package Diagram BG292 Updated all PBGA package type information (BG292 & BG388)